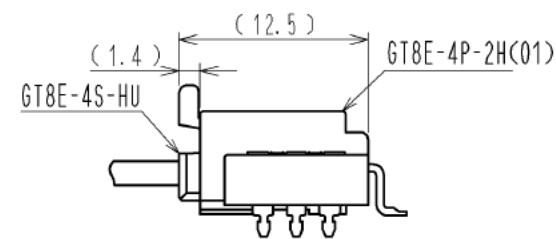
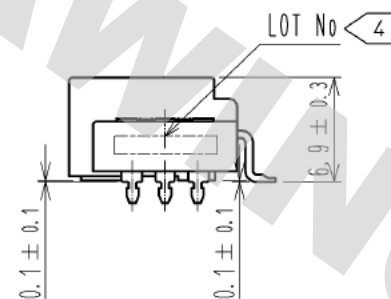
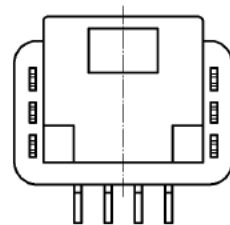
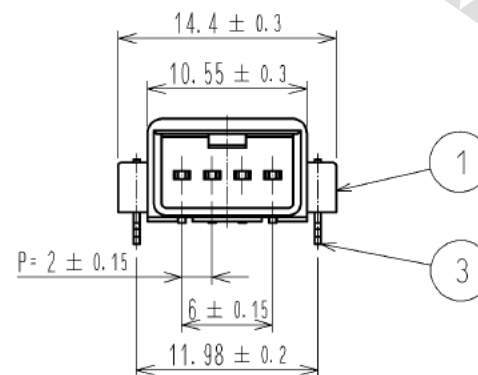
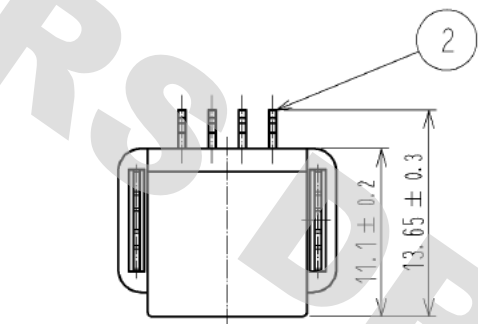
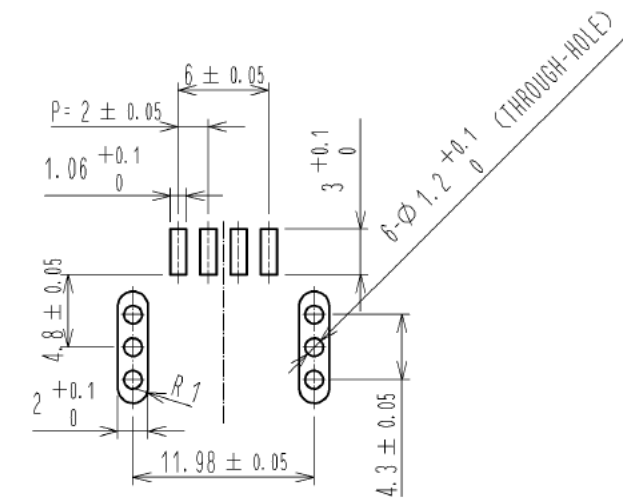


DRAWING FOR REFERENCE: This is subject to change without notice
05/31/2013

ELV. RoHS COMPLIANT



MATING CONFIGURATION

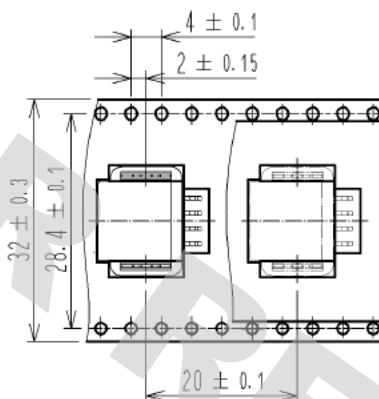


RECOMMENDED PC BOARD PATTERN

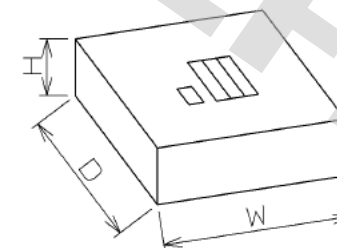
PACKING STYLE

1. Place connectors into an embossed carrier tape.

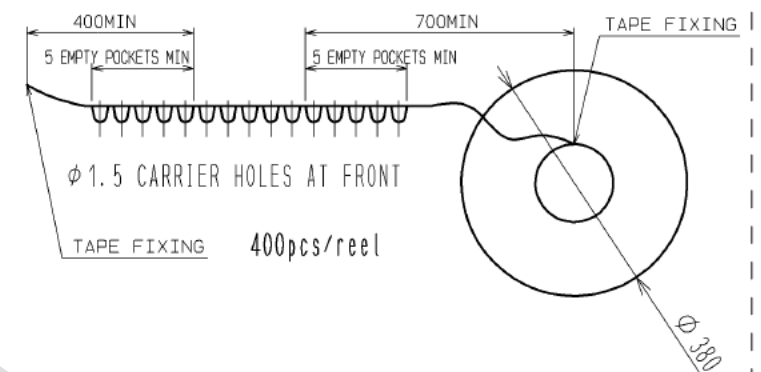
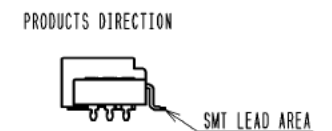
← DIRECTION OF UNREELING



2. Put a reel into a cardboard.



W = (405) (mm)
D = (405) (mm)
H = (39) (mm)



NOTE 1. RECOMMENDED TEMPERATURE PROFILE FOR REFLOW (REFER TO RIGHT FIG.)
REFLOW HEATING METHODS: FAR-INFLARED, IN THE AIR OR NITROGEN

REFLOW No.: MAX 2TIMES
PEAK TEMPERATURE: 250°C
ABOVE 230°C: 20~40s
PREHEAT: 150~180°C
60~120s

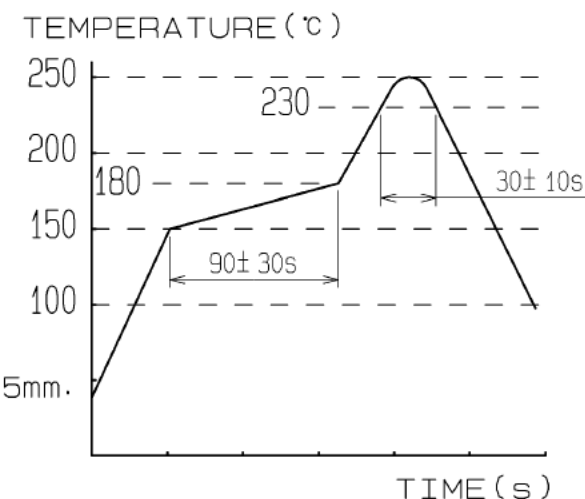
2. SOLDERING TEMPERATURE: 280~300°C, MAX 2s

3. COPLANARITY OF LEADS SHALL BE UNDER 0.1mm.

4. MARKING OF LOT No.:
(EX) 2008. 2ND. JULY → 08G02... 5DIGITS

5. RECOMMENDED THICKNESS FOR PC BOARD IS 1.6mm.

6. RECOMMENDED THICKNESS FOR SOLDER PASTE IS 0.15mm.



2	BRASS	Lead: TIN-COPPER ALLOY PLATING CONTACT: GOLD PLATING			
1	PPS	BLACK	3	BRASS	TIN-COPPER ALLOY PLATING
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT 	DESCRIPTION OF REVISIONS	DESIGNED CHECKED DATE
		HIROSE ELECTRIC CO., LTD.	APPROVED: AR. SHIRAI CHECKED: NH. NAKATA DESIGNED: HH. TSUKUMO DRAWN: YT. HAYAKAWA	12.12.27 12.12.26 12.12.18 12.12.14	DRAWING NO. PART NO. CODE NO.
					EDC3-167409-03 GT8E-4P-2H(C01) CL758-0079-5-01
					1/1